



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!




Contact us

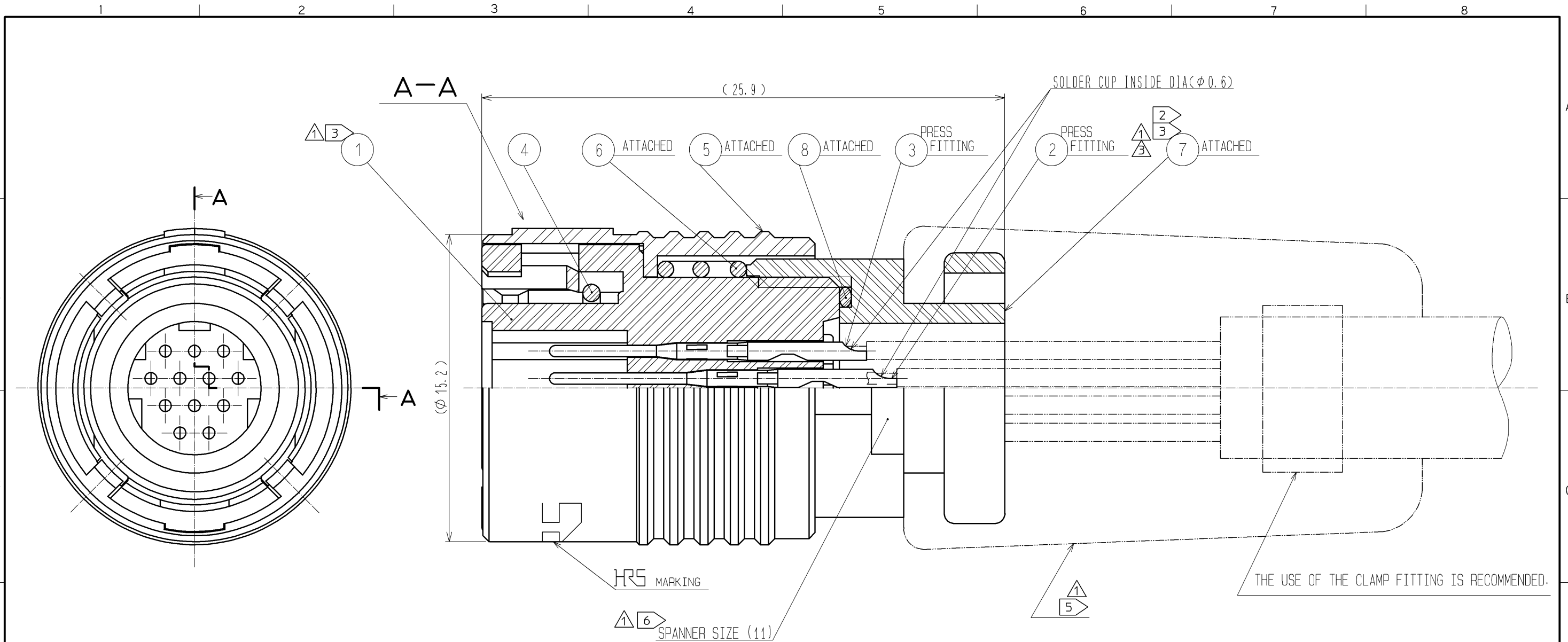
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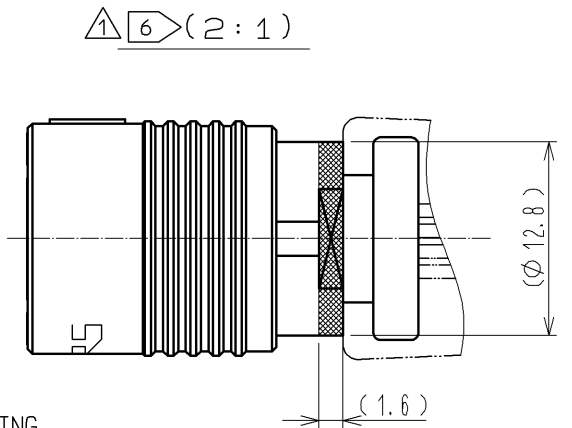
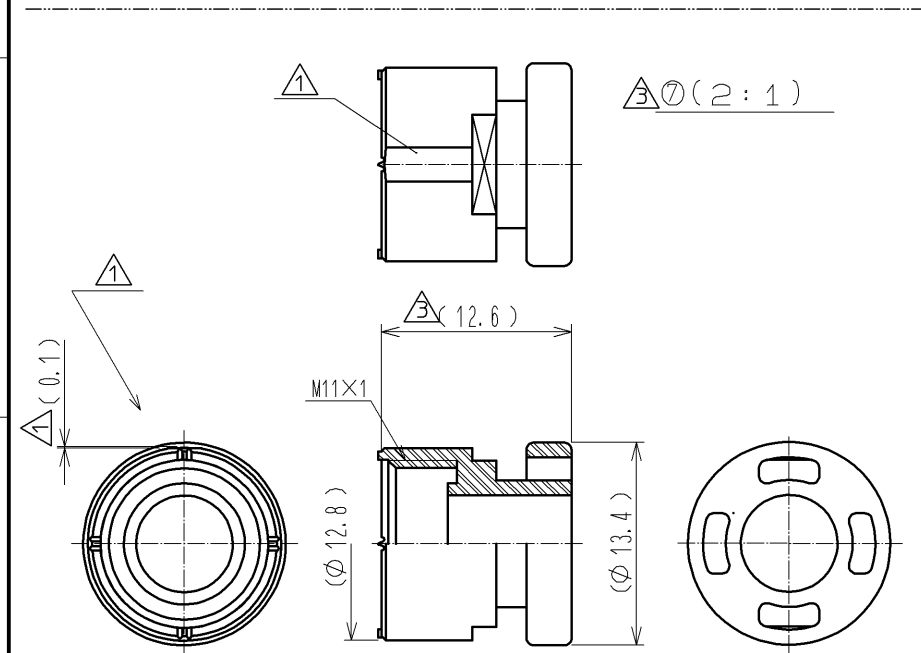
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



APPLICABLE STANDARD					
RATING	OPERATING TEMPERATURE RANGE	-25 °C TO +85 °C	STORAGE TEMPERATURE RANGE	-10 °C TO +60 °C	
	VOLTAGE	AC 30 V, DC 42 V			
	CURRENT	2 A	APPLICABLE CABLE		
SPECIFICATIONS					
ITEM	TEST METHOD		REQUIREMENTS	QT	AT
CONSTRUCTION					
GENERAL EXAMINATION	VISUALLY AND BY MEASURING INSTRUMENT.		ACCORDING TO DRAWING.	X	X
MARKING	CONFIRMED VISUALLY.			X	X
ELECTRIC CHARACTERISTICS					
CONTACT RESISTANCE	CONTACT SHALL BE MEASURED AT DC 1 A		15 mΩ MAX.	X	X
INSULATION RESISTANCE	100 V DC.		1000 MΩ MIN.	X	X
VOLTAGE PROOF	300 V AC. FOR 1 min.		NO FLASHOVER OR BREAKDOWN.	X	X
MECHANICAL CHARACTERISTICS					
CONTACT INSERTION AND WITHDRAWAL FORCES	BY STEEL GAUGE.		INSERTION AND WITHDRAWAL FORCES : — N MIN.	—	—
CONNECTOR INSERTION AND WITHDRAWAL FORCES	MEASURED BY APPLICABLE CONNECTOR.		INSERTION AND WITHDRAWAL FORCES LOCKING DEVICE WITH UNLOCK : — N MAX. LOCKING DEVICE WITH LOCK : 50 N MAX.	X	—
MECHANICAL OPERATION	1000 TIMES INSERTIONS AND EXTRACTIONS.		CONTACT RESISTANCE: 30 mΩ MAX.	X	—
VIBRATION	FREQUENCY: 10 → 55 → 10 (Hz) (1CYC, 5min), SINGLE AMPLITUDE 0.75 mm, AT 10 CYC, FOR 3 DIRECTIONS.		① NO ELECTRICAL DISCONTINUITY OF 10 μs. ② NO DAMAGE, CRACK AND LOOSENESS, OF PARTS.	X	—
SHOCK	490 m/s ² DIRECTIONS OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.		① NO ELECTRICAL DISCONTINUITY OF 10 μs. ② NO DAMAGE, CRACK AND LOOSENESS, OF PARTS.	X	—
ENVIRONMENTAL CHARACTERISTICS					
DAMP HEAT (STEADY STATE)	EXPOSED AT 40 °C, 90 TO 95 %, 96 h.		① INSULATION RESISTANCE: 10 MΩ MIN (AT HIGH HUMIDITY). ② INSULATION RESISTANCE: 100 MΩ MIN (AT DRY). ③ NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	X	—
RAPID CHANGE OF TEMPERATURE	TEMPERATURE -55 → R/T ⁽¹⁾ → +85 → R/T °C TIME 30 → 10 TO 15 → 30 → 10 TO 15 min UNDER 5 CYCLES.		① INSULATION RESISTANCE: 100 MΩ MIN. ② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	X	—
CORROSION SALT MIST	EXPOSED IN 5 % SALT WATER SPRAY FOR 48 h.		NO HEAVY CORROSION RUIN THE FUNCTION.	X	—
DRY HEAT	EXPOSED AT + 85 °C, 96 h.		NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	X	—
COLD	EXPOSED AT - 55 °C, 96 h.		NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	X	—
RESISTANCE TO SOLDERING HEAT	SOLDER TEMPERATURE, + 380±10°C, FOR SOLDERING DURATION, 3 TO 4 s.		NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X	—
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, + 350±10°C FOR SOLDERING DURATION, 2 TO 3 s.		WETTING ON SOLDER SURFACE, NO SOLDER CLUSTER.	X	—
SEALING	EXPOSED AT A DEPTH OF 1 m FOR 0.5 h.		NO WATER PENETRATION INSIDE CONNECTOR.	X	—
AIRTIGHTNESS	APPLY AIR PRESSURE 17.6kPa FOR 0.5min TO INSIDE CONNECTOR.		NO AIR BUBBLES INSIDE CONNECTOR.	X	—
	COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
Q					
REMARK			APPROVED	MO. SATOH	09.02.17
NOTE(1) R/T : ROOM TEMPERATURE			CHECKED	HY. KOBAYASHI	09.02.16
			DESIGNED	TY. SUZUKI	09.02.16
Unless otherwise specified, refer to JIS C 5402.			DRAWN	TY. SUZUKI	09.02.16
Note QT:Qualification Test AT:Assurance Test X:Applicable Test			DRAWING NO.		ELC4-116274-00
HRS	SPECIFICATION SHEET		PART NO.	HR30-8PB-12P	
	HIROSE ELECTRIC CO., LTD.		CODE NO.	CL130-0030-1-00	 1/1



- NOTES
- ① PLATING(REF.NO. ②, ③)
 CONTACT AREA : GOLD PLATING 0.2μm min.
 LEAD AREA : GOLD PLATING FLASH.
 UNDER PLATING : NICKEL PLATING 2μm min.
 - ①② THE RECOMMENDED CLUMP TORQUE OF REF. NO. ⑦ IS 0.5N·m.
 LOCTITE 271, LOCPRIMER 7649, HENKEL JAPAN LTD IS RECOMMENDED TO PREVENT REF. NO. ⑦ FROM LOOSENING.
 - ①③ ROTATION EXAMPLES OF NO.① AND NO.⑦ ARE SHOWN.FOR OVERMOLDING NOTE THAT THE POSITION IS NOT ALWAYS THE SAME.
 - ④ APPLICABLE JIG
 SOLDER TERMINATION FIXTURE : HR30-8P-12PC-TC01(CL150-0227-0)
 - ①②⑤ WHEN THIS PRODUCT ASSEMBLED, IT SHALL APPLY TO ETAD-C0198 AND BE OVERMOLDED BY CUSTOMER.
 CABLE CLAMP STRENGTH, WATERPROOF PERFORMANCE AND OTHER PERFORMANCE DEPEND ON OVERMOLD.
 WE RECOMMENDED CHECKING THE QUALITY BEFORE THE USAGE.
 - ①⑥ THE MOLDING DIE FOR OVERMOLDING SHALL BE DESIGNED AS HOLDING DOWN THE AREA (SPANNER SETTING AREA(11) AND CIRCUMFERENCE OF (φ12.8))AS SHOWN IN THE DRAWING.



NO.	MATERIAL	FINISH	REMARKS	NO.	MATERIAL	FINISH	REMARKS
4	SILICONE RUBBER	(RED)		8	SILICONE RUBBER	(RED)	
3	COPPER ALLOY	①		7	POLYBUTYLENE TEREPHTHALATE	(BLACK) UL94V-0	
2	COPPER ALLOY	①		6	STAINLESS STEEL		
1	POLYPHENYLENE SULFIDE	(BLACK) UL94V-0		5	POLYBUTYLENE TEREPHTHALATE	(BLACK) UL94V-0	

UNITS	SCALE	COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
mm	5 : 1	3	DIS-C-001478	TY. SUZUKI	HY. KISHI	09.11.26

APPROVED	CHECKED	DESIGNED	DRAWN	DATE	DRAWING NO.	PART NO.	CODE NO.
MO. SATOH	HY. KOBAYASHI	HS. KAWASHIMA	TY. SUZUKI	09.02.04 09.02.02 09.02.02 09.01.24	EDC3-116274-00	HR30-8PB-12P	CL130-0030-1-00